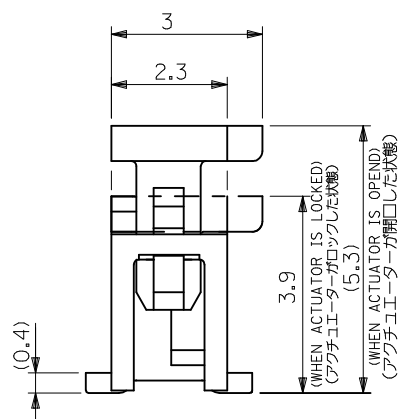
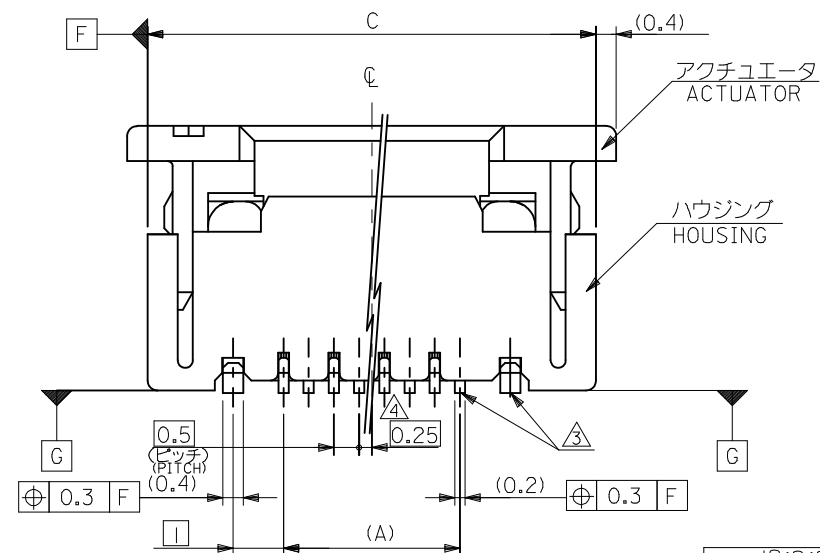
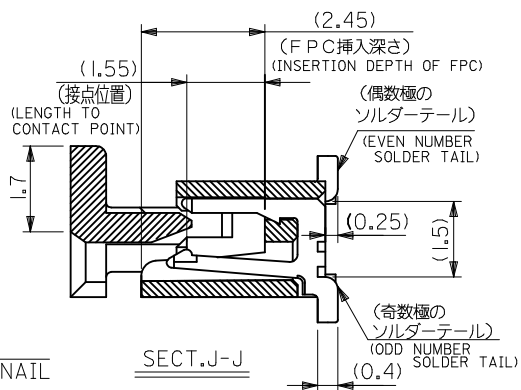
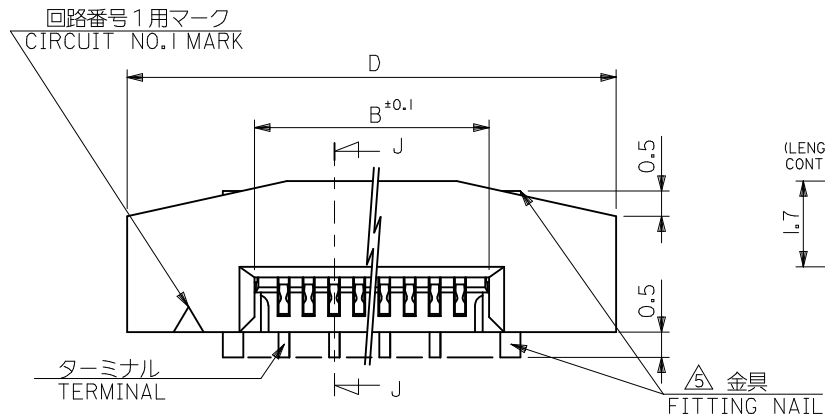




注記 NOTES

1. 使用材料 : MATERIAL

ハウジング : 46NYLON UL94V-0
HOUSING

アクチュエータ : PPS UL94V-0
ACTUATOR

ターミナル : リン青銅 (t=0.2)
TERMINAL PHOS-BRO

: 接点部 金メッキ 0.1マイクロメートル以上
CONTACT GOLD 0.1 MICROMETER MINIMUM

: 半田付け部 錫メッキ 1.0マイクロメートル以上
TAIL TIN 1.0 MICROMETER MINIMUM

: ニッケル下地 1.0マイクロメートル以上
NICKEL (UNDER PLATING) 1.0 MICROMETER MINIMUM

金具 : リン青銅 (t=0.4)
FITTING NAIL PHOS-BRO

: 錫メッキ 1.0マイクロメートル以上
TIN 1.0 MICROMETER MINIMUM

: ニッケル下地 1.0マイクロメートル以上
NICKEL (UNDER PLATING) 1.0 MICROMETER MINIMUM

2. エンボステープ梱包時は、アクチュエータがロックした状態とする。

IN THE PACKAGE, ACTUATOR OF PART NO. 52559-**79 SHOULD BE LOCKED.

△ソルダータール半田付け面のズレ量、及び金具半田付け面のズレ量は、基準面 [G]

に対し上方向 0.05 MAX. , 下方向 0.15 MAX. とする。

MISALIGNMENT OF SOLDER TAILS AND FITTING NAILS FROM [G]
UPPER DIRECTION: 0.05 MAX. , LOWER DIRECTION: 0.15 MAX.

△偶数極に適用。

APPLY FOR EVEN CIRCUIT.

△パターンはくり止め用金具。

FITTING NAIL FOR PREVENTION OF PEELING
OF P.C.B. PATTERN.

△R0.3は、FPCの導体部にカカらないこと。

R0.3 MUST NOT BE OVERLAPPED TO PATTERN
OF FPC.

MODEL NO. 52559-**79

REVISED EC NO.: J2012-0823 DRAWN: KAGUMO CHK'D: KATAHASHI APPR: KIMORI KAWA	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY MNABEI	DATE '04/07/13	TITLE 0.5 FPC CONN ASSY ZIF. -LEAD FREE- MOLEX INCORPORATED				
		10 OVER 30 UNDER	± 0.25	CHECKED BY KTOJO	DATE '04/07/13					
		30 OVER	± 0.3	APPROVED BY NUKITA	DATE '04/07/13					
		ANGULAR ± 3 °		MATERIAL NO. SEE CHART		DOCUMENT NO. SD-52559-048		SHEET NO. 1 OF 2		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						

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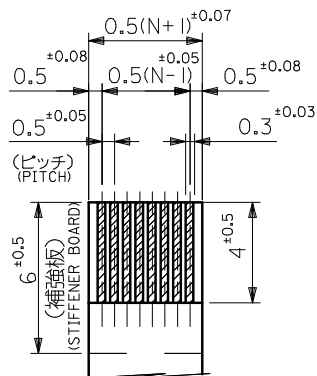
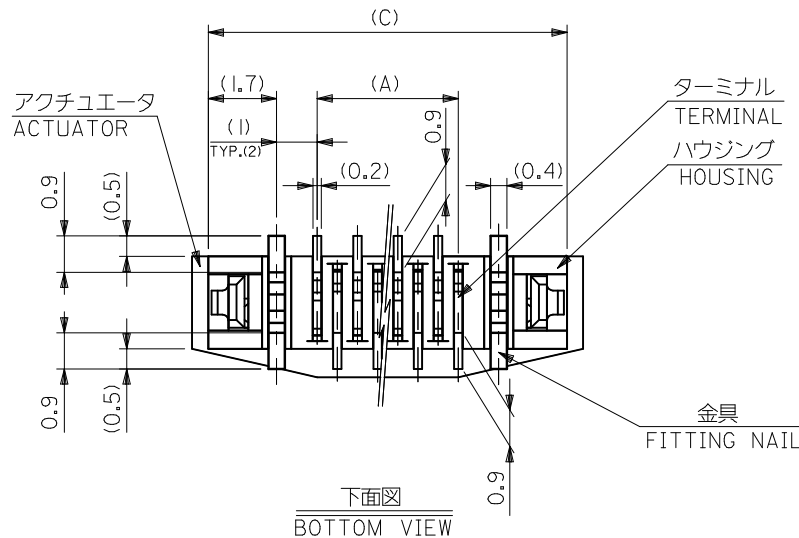
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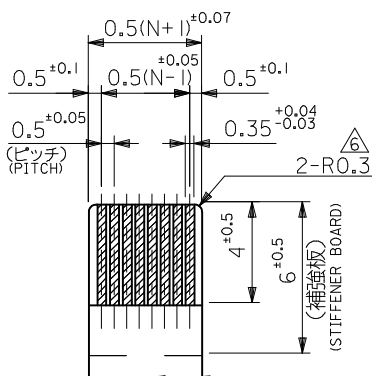
C

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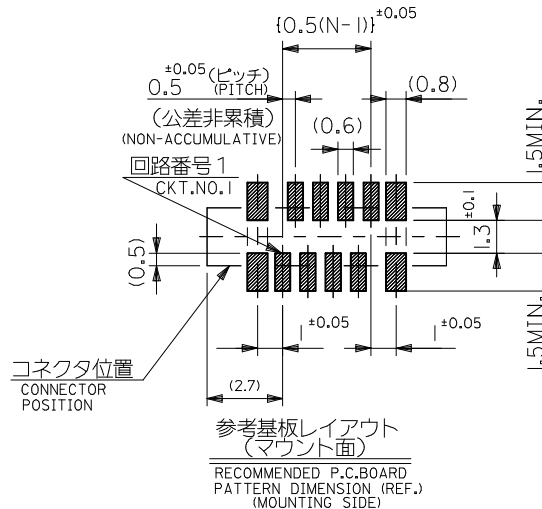
A



適合F F C推奨寸法
APPLICABLE FFC
RECOMMENDED DIMENSION.
(仕上がり厚さ: 0.3^{+0.05}/_{-0.05})
(THICKNESS: 0.3^{+0.05}/_{-0.05})



適合F P C推奨寸法
APPLICABLE FPC
RECOMMENDED DIMENSION.
(仕上がり厚さ: 0.3^{+0.05}/_{-0.05})
(THICKNESS: 0.3^{+0.05}/_{-0.05})

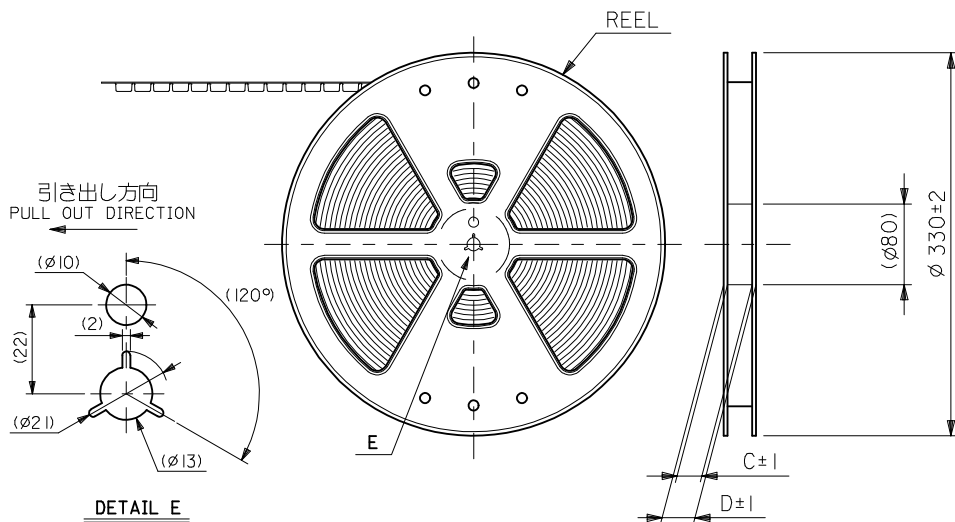


F P Cについて：
打抜き方向は導体側から補強板側を推奨致します。
補強フィルム材質はポリイミドを推奨致します。
接着剤は熱硬化接着剤を推奨致します。

ABOUT FPC :
RECOMMENDED PUNCHER DIRECTION : FROM CONDUCTOR SIDE TO STIFFENER BOARD SIDE.
RECOMMENDED MATERIAL :
STIFFENER FILM : POLYIMIDE
BONDING AGENT : THERMOSETTING BONDING AGENT

25.7	24.9	20.65	19.5	52559-4079	40
23.7	22.9	18.65	17.5	-3679	36
22.2	21.4	17.15	16.0	-3379	33
21.7	20.9	16.65	15.5	-3279	32
21.2	20.4	16.15	15.0	-3179	31
20.7	19.9	15.65	14.5	-3079	30
20.2	19.4	15.15	14.0	-2979	29
19.7	18.9	14.65	13.5	-2879	28
19.2	18.4	14.15	13.0	-2779	27
18.7	17.9	13.65	12.5	-2679	26
18.2	17.4	13.15	12.0	-2579	25
17.7	16.9	12.65	11.5	-2479	24
17.2	16.4	12.15	11.0	-2379	23
16.7	15.9	11.65	10.5	-2279	22
16.2	15.4	11.15	10.0	-2179	21
15.7	14.9	10.65	9.5	-2079	20
15.2	14.4	10.15	9.0	-1979	19
14.7	13.9	9.65	8.5	-1879	18
14.2	13.4	9.15	8.0	-1779	17
13.7	12.9	8.65	7.5	-1679	16
13.2	12.4	8.15	7.0	-1579	15
12.7	11.9	7.65	6.5	-1479	14
12.2	11.4	7.15	6.0	-1379	13
11.7	10.9	6.65	5.5	-1279	12
11.2	10.4	6.15	5.0	-1179	11
10.7	9.9	5.65	4.5	-1079	10
10.2	9.4	5.15	4.0	-0979	9
9.7	8.9	4.65	3.5	-0879	8
8.7	7.9	3.65	2.5	52559-0679	6
D	C	B	(A)	MATERIAL NO.	極数 CKT.

REVISED EC NO: J2012-0823 DRWN:KNAGUMO 2011/12/15 CHKD:KTAHASHI 2011/12/16 APPR:KMORIKAWA 2011/12/16	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY MNABEI	DATE '04/07/13	TITLE 0.5 FPC CONN ASSY ZIF. -LEAD FREE- MOLEX INCORPORATED				
		10 OVER 30 UNDER	± 0.25	CHECKED BY KTOJO	DATE '04/07/13					
		30 OVER	± 0.3	APPROVED BY NUKITA	DATE '04/07/13					
		ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-52559-048		2 OF 2			
B	REV	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								



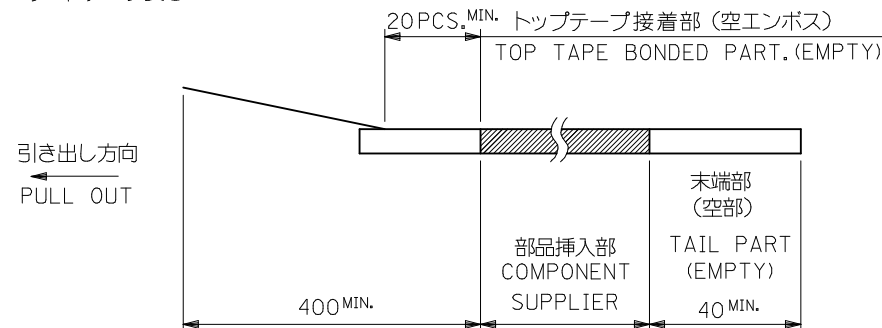
5. 材料 キャリアテープ:ポリプロピレン (PP)
 トップテープ:PET, PE, PEF
 リール:ポリスチレン (PS) <リサイクル材を含む>

MATERIAL CARRIER TAPE:POLYPROPYLENE
TOP TAPE:PET,PE,PEF
REEL:POLYSTYRENE (PS)
<RECYCLE MATERIAL CONTAINED>

6. 本製品は 52559-**-53 のエンボステープ違い品である。
THIS PRODUCT IS EMBOSSED TAPE DIFFERENCE ARTICLE OF 52559-**-53.
7. 本製品は乾燥剤入り、ハイバリア梱包仕様である。
THIS PRODUCT IS HIGH BARRIER PACKAGE WITH DESICCANT.

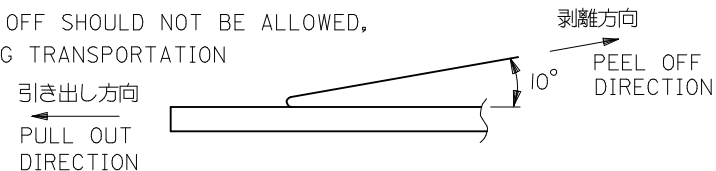
注記 NOTES

- 製品番号 52559-**-79 の梱包状態はアクチュエータがロックした状態とする。
詳細寸法については 製品単体図面を参照下さい。
IN THE PACKAGE,ACTUATOR OF PART NO.52559-**-79 SHOULD BE LOCKED
RE DETAILED DIMENSIONS,SEE ASSY DRAWING
- 梱包数量:1000個/リール
NUMBER OF CONNECTORS:1000PCS/REEL
- リードテープ長さ LEAD TAPE LENGTH



4. トップテープの剥離強度: (剥離方向は下図参照)
0.1N~1.3N {10gf~130gf} 尚、本規格値は、出荷時に適用。
(但し、輸送時に剥離が発生しない事。)

PEELING OFF FORCE OF TOP TAPE
0.1N~1.3N {10gf~130gf}(PEELING DIRECTION AS SHOWN IN FOLLOWING FIG.)
THIS REQUIREMENT SHOULD BE APPLIED AT SHIPMENT
PEEL OFF SHOULD NOT BE ALLOWED,
DURING TRANSPORTATION



REVISED EC NO: J2013-0959 DRWN: TMORISHITA 2013/03/01 CHKD: KTAHASHI 2013/03/01 APPR: KMORIKAWA 2013/03/01 REV H	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY MNABEI	DATE '04/07/13	TITLE 0.5 FPC CONN ASSY ZIF FOR SMT EMBSTP PKG -LEAD FREE- molex				
		10 OVER 30 UNDER	± 0.25	CHECKED BY KTOJO	DATE '04/07/13					
		30 OVER	± 0.3	APPROVED BY NUKITA	DATE '04/07/13					
		ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-52559-049		1 OF 4			
		SIZE A3 THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								

10 9 8 7 6 5 4 3 2 1

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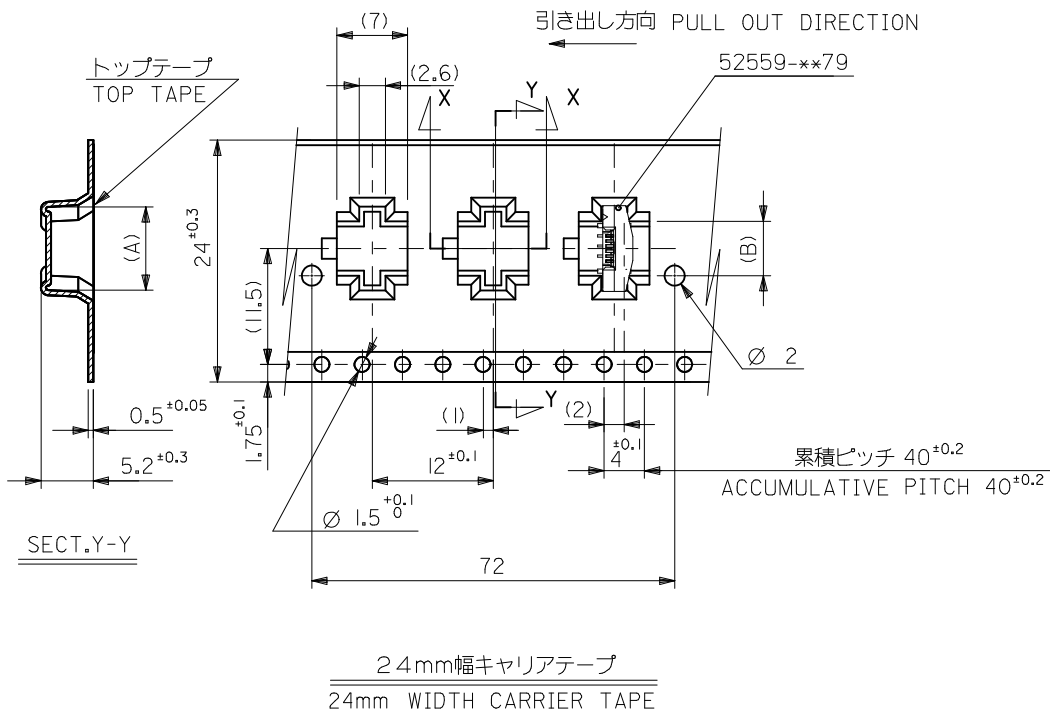
E

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24	29.4	25.4	14.4	17.3	52559-2452	24
			13.9	16.8	52559-2352	23
			12.9	15.8	52559-2152	21
			12.4	15.3	52559-2052	20
			10.9	13.8	52559-1752	17
			10.4	13.3	52559-1652	16
			9.9	12.8	52559-1552	15
			9.4	12.3	52559-1452	14
			8.4	11.3	52559-1252	12
			7.4	10.3	52559-1052	10
キャリアテープ幅 CARRIER TAPE WIDTH	D	C	6.9	9.8	52559-0952	9
			5.4	8.3	52559-0652	6
			(B)	(A)	MATERIAL NO.	CIRCUIT NO.

REVISED EC NO: J2013-0959 DRWN: TMORISHITA 2013/03/01 CHKD: KTAHASHI 2013/03/01 APPR: KMORIKAWA 2013/03/01	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION		
				MM ONLY		---	METRIC			
		10 UNDER	±0.2	DRAWN BY	DATE	TITLE 0.5 FPC CONN ASSY ZIF FOR SMT EMBSTP PKG -LEAD FREE-				
		10 OVER 30 UNDER	±0.25	CHECKED BY	DATE					
		30 OVER	±0.3	APPROVED BY	DATE	molex				
		ANGULAR ±3 °		NUKITA	'04/07/13					
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	MATERIAL NO.		DOCUMENT NO.		SHEET NO.				
		SEE CHART		SD-52559-049		2 OF 4				
1	REV			SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

10 9 8 7 6 5 4 3 2 1

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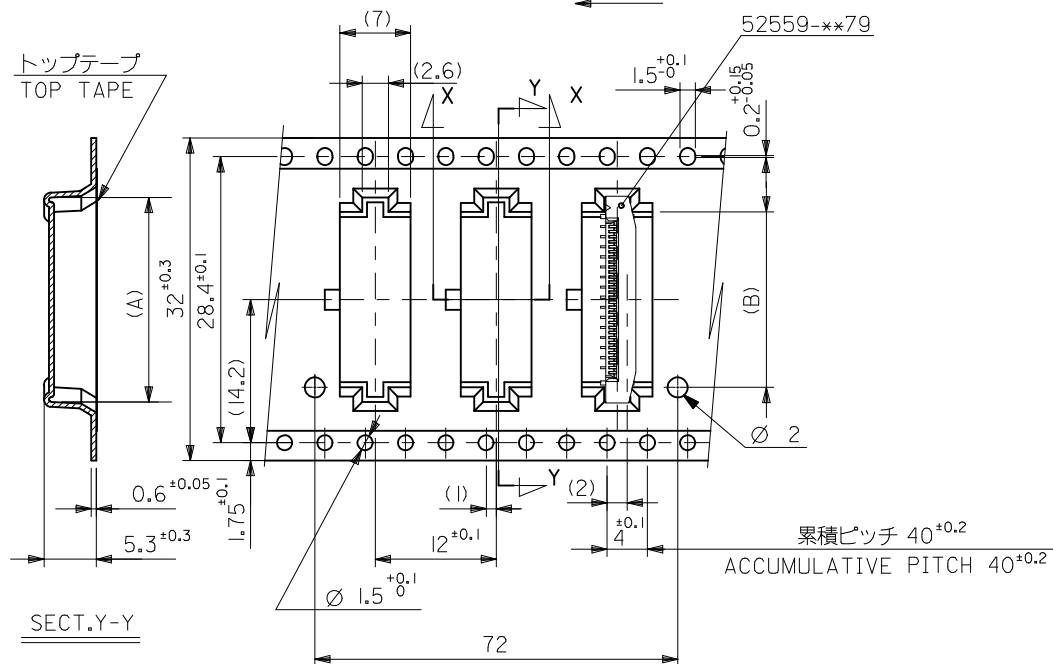
B

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引き出し方向 PULL OUT DIRECTION

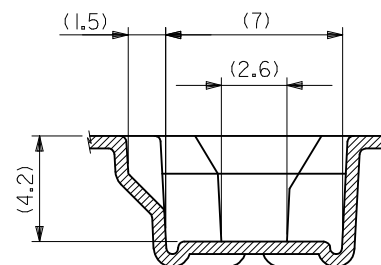
52559-**79

トップテープ
TOP TAPE



SECT.Y-Y

32mm幅キャリアテープ
32mm WIDTH CARRIER TAPE



SECT.X-X

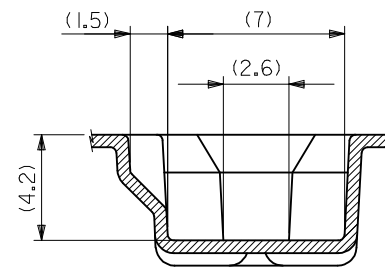
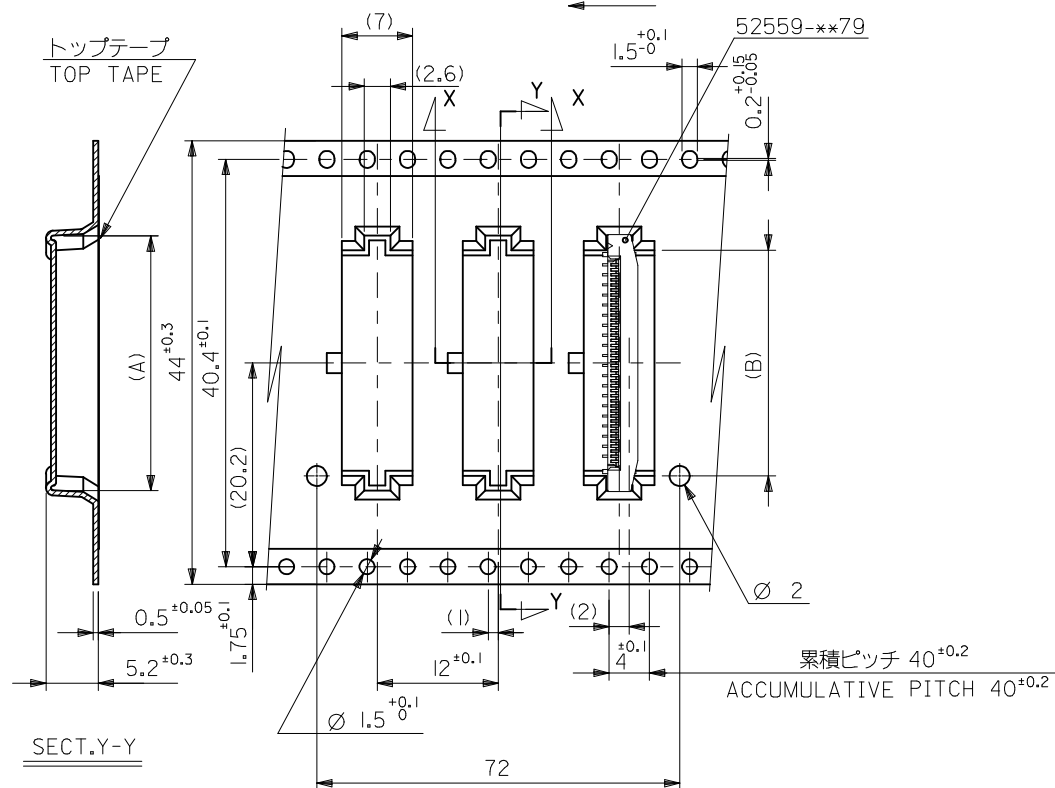
32	37.4	33.4	18.4	21.3	52559-3252	32
			17.4	20.3	52559-3052	30
			16.4	19.3	52559-2852	28
			15.9	18.8	52559-2752	27
			15.4	18.3	52559-2652	26
キャリアテープ幅 CARRIER TAPE WIDTH	D	C	(B)	(A)	MATERIAL NO.	CIRCUIT NO.

REVISED EC NO: J2013-0959 DRWN: TMORISHITA 2013/03/01 CHKD: TAKAHASHI 2013/03/01 APPR: KMORIKAWA 2013/03/01	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY MNABEI	DATE '04/07/13	TITLE 0.5 FPC CONN ASSY ZIF FOR SMT EMBSTP PKG -LEAD FREE- molex				
		10 OVER 30 UNDER	± 0.25	CHECKED BY KTOJO	DATE '04/07/13					
		30 OVER	± 0.3	APPROVED BY NUKITA	DATE '04/07/13					
		ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-52559-049		3 OF 4			
	1	REV	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

9 8 7 6 5 4 3 2

10 9 8 7 6 5 4 3 2 1

引き出し方向 PULL OUT DIRECTION



SECT.X-X

44mm 幅キャリアテープ
44mm WIDTH CARRIER TAPE

44	49.4	45.4	22.4	25.3	52559-4052	40
キャリアテープ幅 CARRIER TAPE WIDTH	D	C	20.4	23.3	52559-3652	36
DIMENSION STYLE MM ONLY			SCALE ---	DESIGN UNITS METRIC	◎ 第三角投影 THIRD ANGLE PROJECTION	
DRAWN BY MNABEI	DATE '04/07/13	TITLE 0.5 FPC CONN ASSY ZIF FOR SMT EMBSTP PKG -LEAD FREE- molex				
CHECKED BY KTOJO	DATE '04/07/13					
APPROVED BY NUKITA	DATE '04/07/13					
MATERIAL NO. SEE CHART			DOCUMENT NO. SD-52559-049			SHEET NO. 4 OF 4
SIZE A3 THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						

9 8 7 6 5 4 3 2

10 9 8 7 6 5 4 3 2 1

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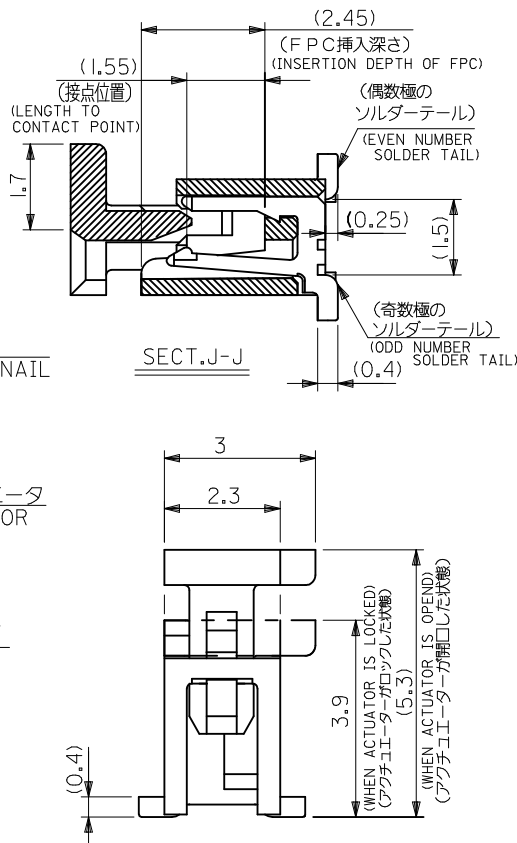
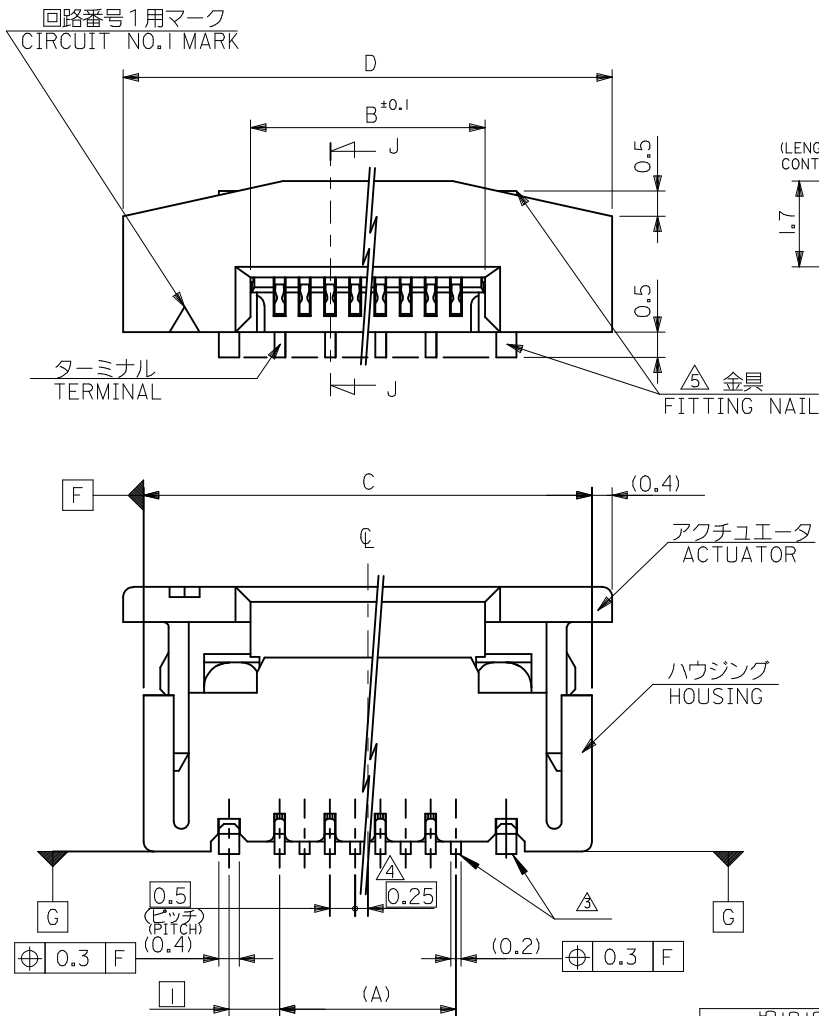
E

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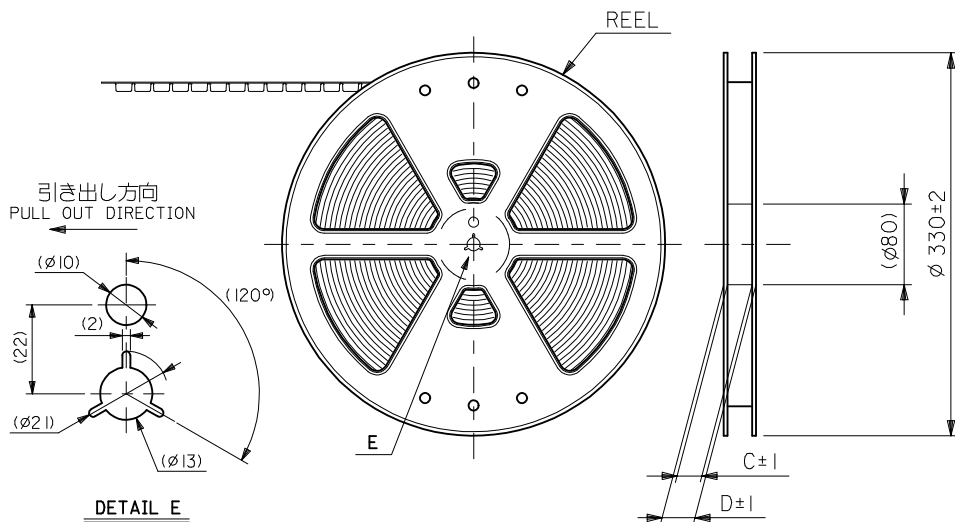
A



注記 NOTES

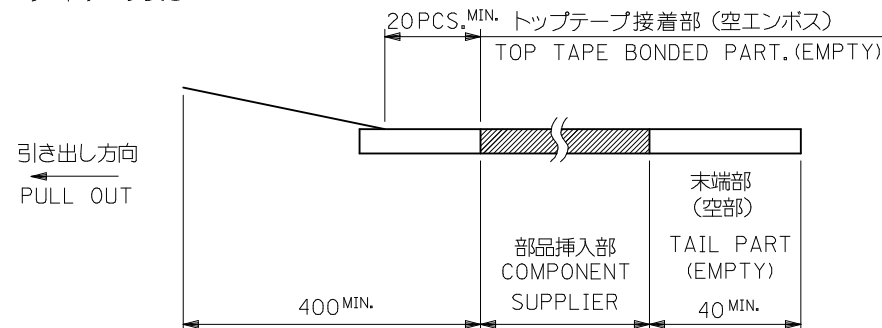
- 材質 MATERIAL
ハウジング: PA46 (46ナイロン)、ガラス充填、ナチュラル(白)、UL94V-0
HOUSING : PA46 , GLASS FILLED, NATURAL, UL94V-0
アクチュエータ: PPS, ガラス充填、ナチュラル、UL94V-0
ACTUATOR : PPS (POLYPHENYLENE SULFIDE) ,
GLASS FILLED, NATURAL, UL94V-0
ターミナル: 銅合金 (t = 0.2)
TERMINAL : COPPER ALLOY (t = 0.2)
金具: 銅合金 (t = 0.4)
NAIL : COPPER ALLOY (t = 0.4)
 - めっき仕様 PLATING
ターミナル TERMINAL
錫銀ビスマスめっき(1.0 μm以上)
下地: ニッケルめっき(1.0 μm以上)
TIN SILVER BISMUTH PLATING
(1.0 MICROMETER MINIMUM)
UNDER PLATE : NICKEL PLATING
(1.0 MICROMETER MINIMUM)
金具 FITTING NAIL
銅めっき(1.0 μm以上)
下地: ニッケルめっき(1.0 μm以上)
TIN PLATING
(1.0 MICROMETER MINIMUM)
UNDER PLATE : NICKEL PLATING
(1.0 MICROMETER MINIMUM)
- △ ソルダーテール半田付け面のズレ量、及び金具半田付け面のズレ量は、
基準面 ⑩ に対し上方向0.05MAXIMUM、下方向0.15MAXIMUMとする。
MISALIGNMENT OF SOLDER TAILS AND FITTING NAILS FROM ⑩
UPPER DIRECTION : 0.05MAXIMUM
LOWER DIRECTION 0.15MAXIMUM.
- △ 偶数極に適用。
APPLY FOR EVEN CIRCUIT.
- △ パターンはくり止め用金具。
FITTING NAIL FOR PREVENTION OF PEELING
OF P.C.B. PATTERN.
- △ R.O. 3は、FPCの導体部にかからないこと。
R0.3 MUST NOT BE OVERLAPPED TO PATTERN
OF FPC.
7. エンボステープ梱包時は、アクチュエータがロックした状態とする。
IN THE PACKAGE,ACTUATOR OF PART NO. 52559-**-**22 SHOULD BE LOCKED.
8. ELV及びRoHS適合品
ELV AND RoHS COMPLIANT.

RELEASED EC NO.: J2013-1014 DRAWN: AISHII CHK'D: KTAKAHASHI APPR: KMORIKAWA	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY AISHII	DATE 2012/09/05	TITLE 0.5MM FPC CONN ZIF S/T HOUSING ASSY				
		10 OVER 30 UNDER	± 0.25	CHECKED BY KTAKAHASHI	DATE 2012/09/05					
		30 OVER	± 0.3	APPROVED BY KMORIKAWA	DATE 2013/03/15					
		ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.				
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-52559-057					1 OF 2
0	REV	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								



注記 NOTES

- 製品番号 52559-**22 の梱包状態はアクチュエータがロックした状態とする。
詳細寸法については SD-52559-057 を参照下さい。
IN THE PACKAGE, ACTUATOR OF PART NO. 52559-**22 SHOULD BE LOCKED FOR DIMENSIONS OF PRODUCT, REFER TO SD-52559-057.
- 梱包数量: 1000個/リール
NUMBER OF CONNECTORS: 1000PCS/REEL
- リードテープ長さ LEAD TAPE LENGTH



- カバートープの剥離強度については、IEC60286-3に準拠
COVER TAPE PEEL FORCE IS DEFINED BY IEC 60286-3.
- 材料
キャリアテープ: ポリプロピレン (PP)
トップテープ: PET, PE, PEF
リール: ポリスチレン (PS) <リサイクル材を含む>

MATERIAL CARRIER TAPE: POLYPROPYLENE
TOP TAPE: PET, PE, PEF
REEL: POLYSTYRENE (PS)
<RECYCLE MATERIAL CONTAINED>
- ELV及RoHS適合品
ELV AND RoHS COMPLIANT

RELEASED EC NO: J2013-1014 DRW: AISHII CHKD: TAKAHASHI APPR: KMORIKAWA	2012/09/05	2012/09/05	2013/03/15	DESCRIPTION REV 0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
	10 UNDER		± 0.2		DRAWN BY AISHII		DATE 2012/09/05	TITLE EMBOSS TAPE PACKAGED FOR 0.5MM FPC CONN ZIF S/T HOUSING ASSY				
	10 OVER 30 UNDER		± 0.25		CHECKED BY TAKAHASHI		DATE 2012/09/05					
	30 OVER		± 0.3		APPROVED BY KMORIKAWA		DATE 2013/03/15	DOCUMENT NO. SD-52559-058 molex SHEET NO. 1 OF 4				
	ANGULAR ±3 °		MATERIAL NO.									
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART									
					SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						

10 9 8 7 6 5 4 3 2 1

F

E

D

C

B

A

F

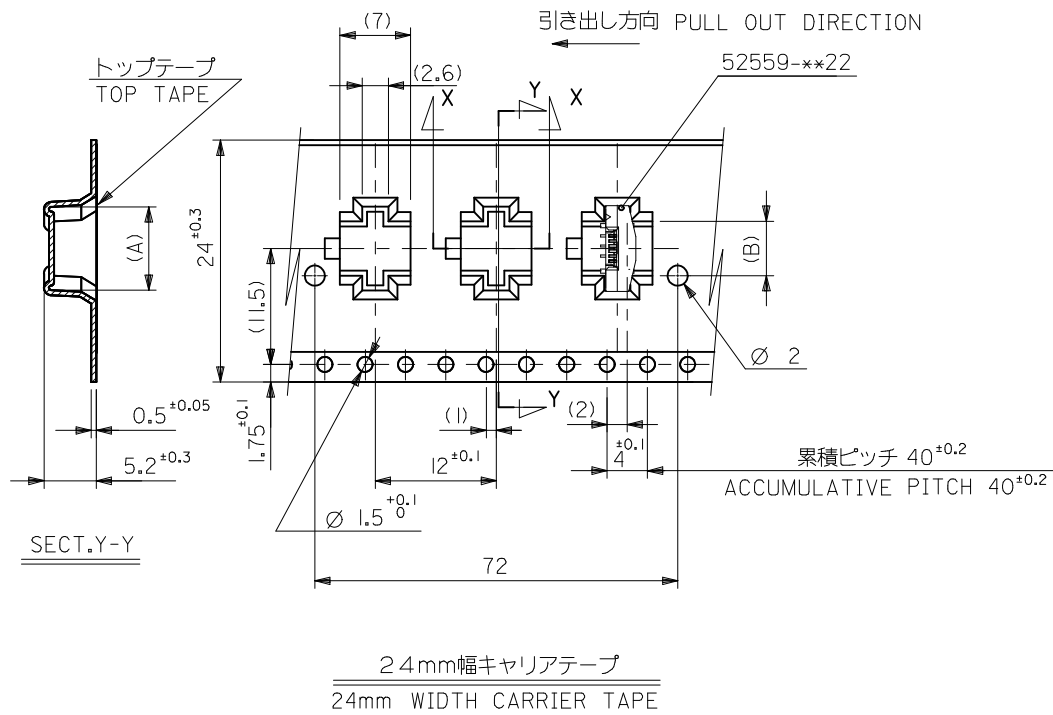
E

D

C

B

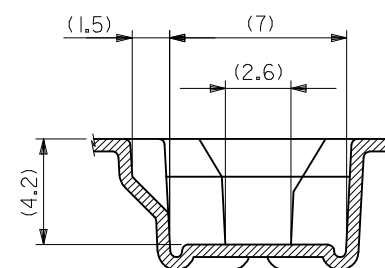
A



24	29.4	25.4	14.4	17.3	52559-2433	24
			13.9	16.8	52559-2333	23
			12.9	15.8	52559-2133	21
			12.4	15.3	52559-2033	20
			10.9	13.8	52559-1733	17
			10.4	13.3	52559-1633	16
			9.9	12.8	52559-1533	15
			9.4	12.3	52559-1433	14
			8.4	11.3	52559-1233	12
			7.4	10.3	52559-1033	10
			6.9	9.8	52559-0933	9
5.4	8.3	52559-0633	6			
キャリアテープ幅 CARRIER TAPE WIDTH	D	C	(B)	(A)	EMBOSSED PACKAGE	極数 CKT.
					オーダー番号 ORDER No.	

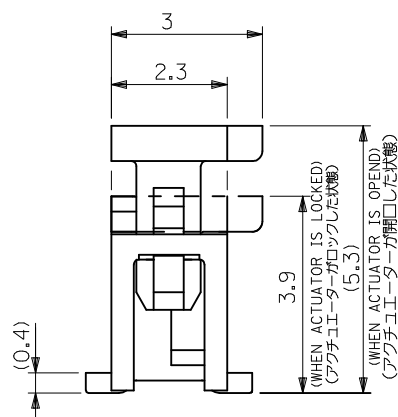
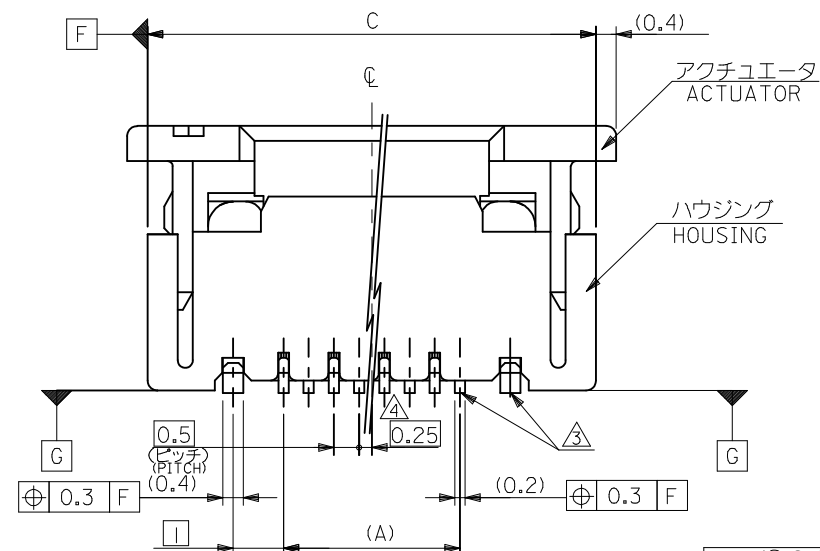
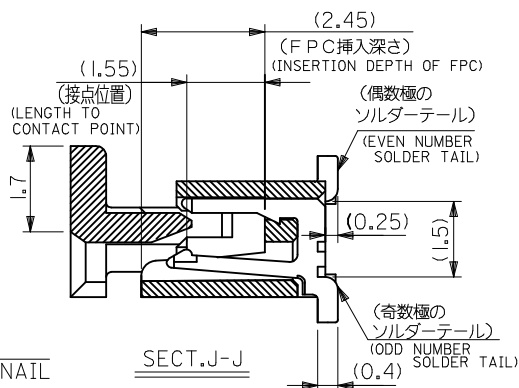
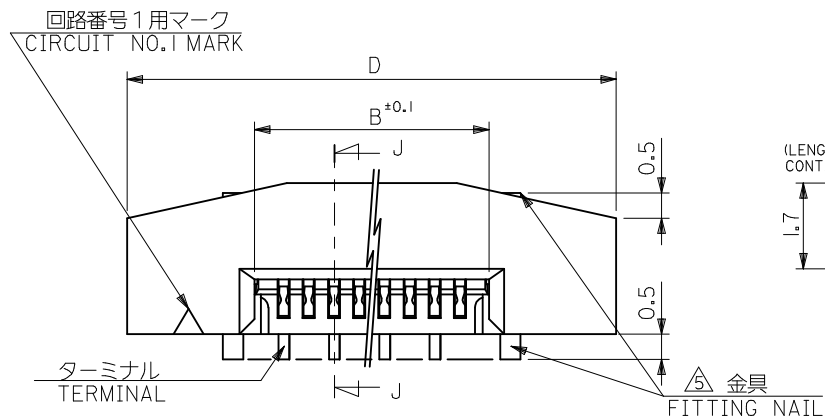
SEE SHEET 1 OF 4 EC NO: J2013-1014 DRAWN: AISHII 2012/09/05 CHKD: KATAHASHI 2012/09/05 APPR: KMORIKAWA 2013/03/15	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION					
		10 UNDER	±0.2	DRAWN BY AISHII	DATE 2012/09/05	TITLE EMBOSS TAPE PACKAGED FOR 0.5MM FPC CONN ZIF S/T HOUSING ASSY							
		10 OVER 30 UNDER	±0.25	CHECKED BY KATAHASHI	DATE 2012/09/05								
		30 OVER	±0.3	APPROVED BY KMORIKAWA	DATE 2013/03/15	molex							
		ANGULAR ±3 °		MATERIAL NO.							DOCUMENT NO.		
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-52559-058						2 OF 4		
	REV 0			SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								

9 8 7 6 5 4 3 2



32mm幅キャリアテープ

SEE SHEET 1 OF 4 EC NO: J2013-1014 DRAWN: AISHI 2012/09/05 CHK'D: TAKAHASHI 2012/09/05 APPR: KMORI KAWA 2013/03/15	DESCRIPTION GENERAL TOLERANCES (UNLESS SPECIFIED) 10 UNDER ±0.2 10 OVER 30 UNDER ±0.25 30 OVER ±0.3 ANGULAR ±3 ° DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
		DRAWN BY DATE AISHI 2012/09/05		TITLE EMOSS TAPE PACKAGED FOR 0.5MM FPC CONN ZIF S/T HOUSING ASSY molex		
		CHECKED BY DATE TAKAHASHI 2012/09/05				
		APPROVED BY DATE KMORI KAWA 2013/03/15		DOCUMENT NO. SD-52559-058 SHEET NO. 3 OF 4		
		MATERIAL NO. SEE CHART				
REV 0		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				



注記 NOTES

1. 使用材料 : MATERIAL

ハウジング : 46NYLON UL94V-0
HOUSING

アクチュエータ : PPS UL94V-0
ACTUATOR

ターミナル : リン青銅 (t=0.2)
TERMINAL PHOS-BRO

: 接点部 金メッキ 0.1マイクロメートル以上
CONTACT GOLD 0.1 MICROMETER MINIMUM

: 半田付け部 錫メッキ 1.0マイクロメートル以上
TAIL TIN 1.0 MICROMETER MINIMUM

: ニッケル下地 1.0マイクロメートル以上
NICKEL (UNDER PLATING) 1.0 MICROMETER MINIMUM

金具 : リン青銅 (t=0.4)
FITTING NAIL PHOS-BRO

: 錫メッキ 1.0マイクロメートル以上
TIN 1.0 MICROMETER MINIMUM

: ニッケル下地 1.0マイクロメートル以上
NICKEL (UNDER PLATING) 1.0 MICROMETER MINIMUM

2. エンボステープ梱包時は、アクチュエータがロックした状態とする。 IN THE PACKAGE, ACTUATOR OF PART NO. 52559-**79 SHOULD BE LOCKED.

△ソルダータール半田付け面のズレ量、及び金具半田付け面のズレ量は、基準面 [G] に対し上方向 0.05 MAX. , 下方向 0.15 MAX. とする。

MISALIGNMENT OF SOLDER TAILS AND FITTING NAILS FROM [G] UPPER DIRECTION: 0.05 MAX. , LOWER DIRECTION: 0.15 MAX.

△偶数極に適用。
APPLY FOR EVEN CIRCUIT.

△パターンはくり止め用金具。
FITTING NAIL FOR PREVENTION OF PEELING OF P.C.B. PATTERN.

△R0.3は、FPCの導体部にかからないこと。
R0.3 MUST NOT BE OVERLAPPED TO PATTERN OF FPC.

MODEL NO. 52559-**79

REVISED EC NO: J2012-0823 DRAWN:KAGUMO CHK'D:K TAKAHASHI APPR:K MORIKAWA	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY MNABEI	DATE '04/07/13	TITLE 0.5 FPC CONN ASSY ZIF. -LEAD FREE- MOLEX INCORPORATED				
		10 OVER 30 UNDER	± 0.25	CHECKED BY KTOJO	DATE '04/07/13					
		30 OVER	± 0.3	APPROVED BY NUKITA	DATE '04/07/13					
		ANGULAR ±3 °		MATERIAL NO. SEE CHART					DOCUMENT NO. SD-52559-048	SHEET NO. 1 OF 2
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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